

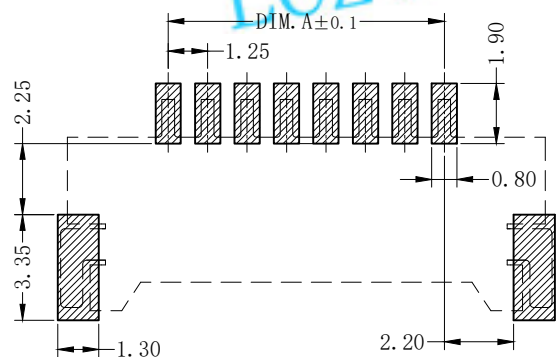
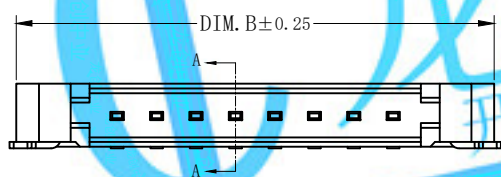
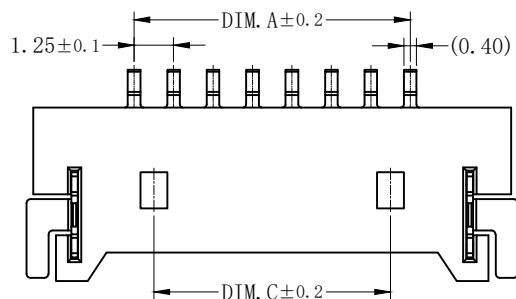
借用登记

旧底图总号

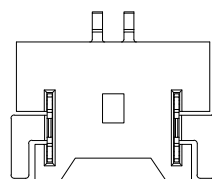
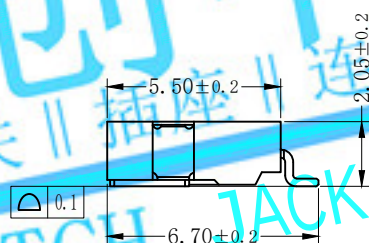
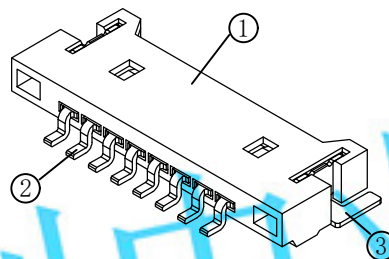
底图总号

签字

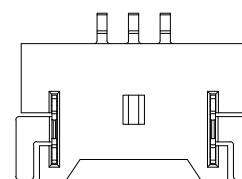
日期



SUGGESTED PCB LAYOUT
(COMPONENT SIDE)



2P



SECTION A-A

技术要求:

- 1、塑件材料: LCP (UL-94V-0)
- 2、接触件: 磷铜镀金
- 3、接触电阻: $\leq 20\text{m}\Omega$
- 4、绝缘电阻: $\geq 100\text{M}\Omega$
- 5、额定电压: 125V AC DC
- 6、额定电流: 1.0A AC DC
- 7、耐压: 能承受500V AC/Min ute
- 8、工作温度: $-25^{\circ}\sim +85^{\circ}$
- 9、可焊性试验: 浸锡面积 $\geq 95\%$ 温度 $260^{+5}_{-0}\text{j}\ddot{\text{a}}$, 时间 2.5 ± 0.5 秒
- 10、铅和镉等六大有害物质含量要符合环保要求

PH-1.25-XP-WT-UTW

Circuit	Dimensions (mm)		
	A	B	C
02	1.25	7.65	-
03	2.50	8.90	-
04	3.75	10.15	2.50
05	5.00	11.40	3.75
06	6.25	12.65	5.00
07	7.50	13.90	6.25
08	8.75	15.15	7.50
09	10.00	16.40	8.75
10	11.25	17.65	10.00
11	12.50	18.90	11.25
12	13.75	20.15	12.50
...	...	...	...
20	23.75	30.15	22.50

3	焊片 Fitting Nail	磷青铜 Phosphor Bronze	2	电镀(金): 整个表面镀底镍30u"MIN, 再镀金0.8u".
2	端子 Contact	磷青铜 Phosphor Bronze	n*1	电镀(金): 整个表面镀底镍30u"MIN, 再镀金0.8u".
1	基座 Wafer	LCP (UL94V-0)	1	本色
序号	名称	材料	数量	附注

GENERAL TOLERANCES				DRAWN BY		龙创中业电子科技(东莞)有限公司	
0.X	±0.25	X.°	±3°	CHK. BY			
0.XX	±0.12			APRV. BY			
0.XXX	±0.05	X.X°	±0.5°			SHEET	PROD. NAME -
UNIT	SIZE	SCALE		DRAWING NO.		1 OF 1	PART NO. PH-1.25-XP-WT-UTW
MM	A4	1:1		006-0082-001		TITLE 1.25 FPC CONN. ZIF SMT FRONTFLIP H=2.0 DOUBLE LOWER CONTACT	